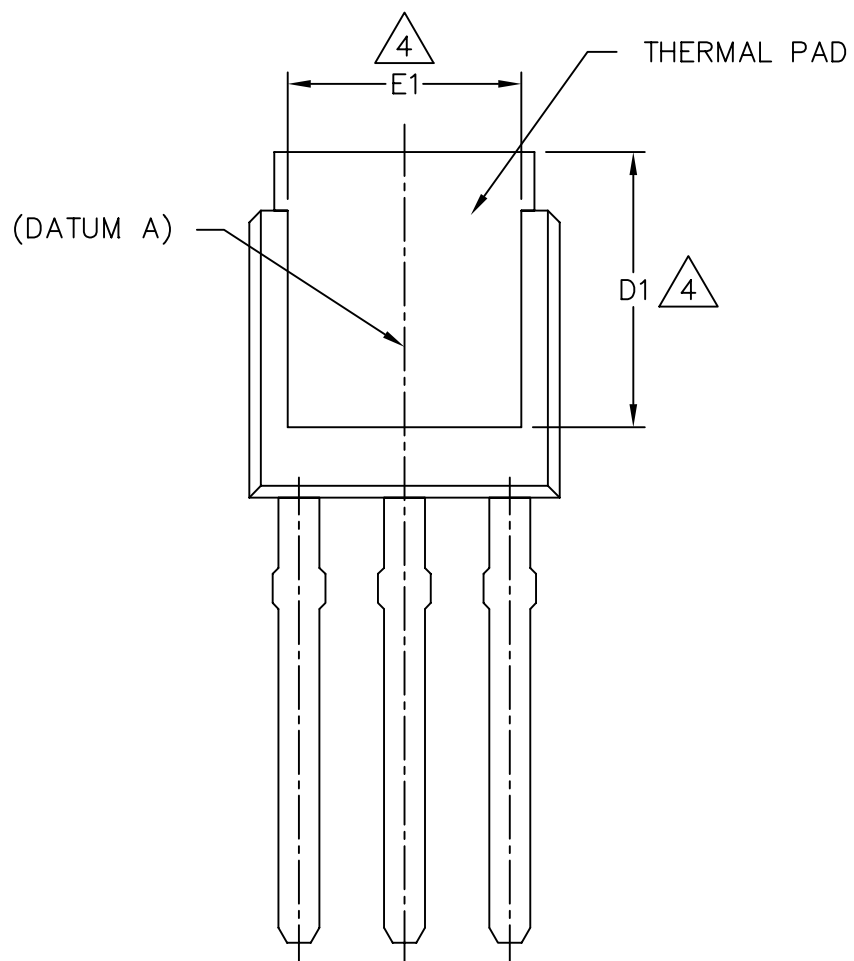
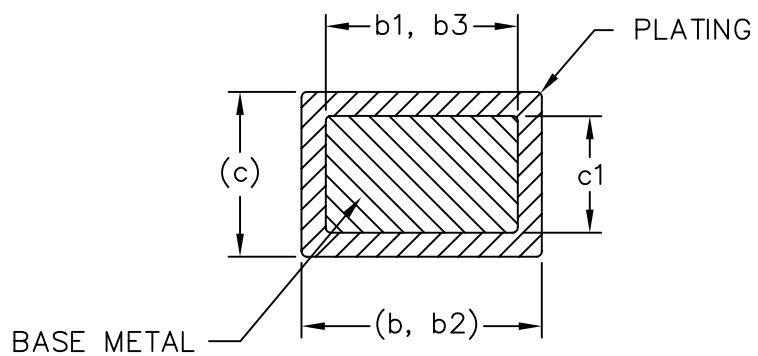


JEDEC SOLID STATE PRODUCT OUTLINE	THIS <b>REGISTERED OUTLINE</b> HAS BEEN PREPARED BY THE JEDEC JC-11 COMMITTEE AND APPROVED BY THE JEDEC COUNCIL AND REFLECTS A PRODUCT WITH WIDE ACCEPTANCE IN THE ELECTRONICS INDUSTRY; CHANGES ARE LIKELY TO OCCUR.					
TITLE FLANGE MOUNTED FAMILY INSERTION MOUNT (PERIPHERAL TERMINALS)	PACKAGE DESIGNATOR R-PSIP-F3	ISSUE D	DATE 6/02	TO-251	SHEET 1 OF 3	



VIEW A-A



SECTION B-B & C-C

JEDEC SOLID STATE PRODUCT OUTLINE	TITLE FLANGE MOUNTED FAMILY INSERTION MOUNT (PERIPHERAL TERMINALS)	ISSUE D	DATE 6/02	TO-251	SHEET 2 OF 3
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NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994

2. DIMENSIONS ARE SHOWN IN INCHES.

3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 INCH PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b4, L2, E1 AND D1.

5. LEAD DIMENSION UNCONTROLLED IN L3.

VARIATIONS (ALL DIMENSIONS SHOWN IN INCHES)								
SYMBOL	AA			NOTES	AB			NOTES
	MIN	NOM	MAX		MIN	NOM	MAX	
A	.086	—	.094		.086	—	.094	
A1	.035	—	.045		.040	—	.050	
b	.025	—	.035		.025	—	.035	
b1	.025	.028	.031		.025	.028	.031	
b2	.030	—	.045		.030	—	.045	
b3	.030	—	.041		.030	—	.041	
b4	.195	—	.215	4	.195	—	.215	4
c	.018	—	.024		.018	—	.024	
c1	.016	—	.022		.016	—	.022	
c2	.018	—	.035		.018	—	.035	
D	.235	.240	.245	3,4	.210	.215	.220	3,4
D1	.205	—	—	4	.205	—	—	4
E	.250	—	.265	3,4	.250	—	.265	3,4
E1	.170	—	—	4	.170	—	—	4
e	.090 BSC				.090 BSC			
L	.350	.362	.380		.615	.630	.645	
L1	.075	—	.090		.125	—	.145	
L2	.035	—	.050	4	.060	—	.080	4
L3	.045	—	.060		.045	—	.060	
θ1	0°	—	15°		0°	—	15°	
N	4				4			
NOTES	1,2				1,2			
REF	10-417				10-417			
ISSUE	D				D			